



**THE DATASHEET OF
AP9106GTR-G1**



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Description

AP9106 is 8-Channel analog switch which is suitable for up to 6-Cells in serial Li+/Polymer battery pack application.

AP9106 has four logic selection inputs (A/B/C/D). When all logic pins are set low, no channel is selected and the chip is turned off with shutdown mode. The A, B, C and D selection pins are compatible with TTL/CMOS logic level, can be connected to MCU I/O port directly to select the right channel respectively. The VOUT is output pin to indicate exactly the voltage of each battery cell.

AUX7, AUX8 pins are auxiliary channels, which can be connected to the NTC resistor to transfer the voltage variation into VOUT pin.

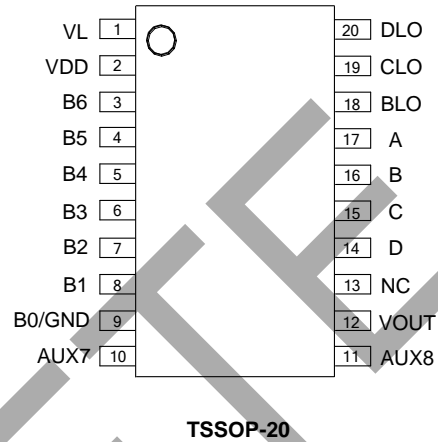
AP9106 is available in standard package of TSSOP-20.

Features

- $\pm 1\%$ Matching Error between any 2 Channels
- Up to 6-Cells in Serial Li+/Polymer Battery Pack Application with Single Chip
- Up to 11-cell in Serial Li+/Polymer Battery Pack Application with Dual Chip
- Ultra Low Current in Shutdown Mode: 1.0 μ A
- Compatible with TTL/CMOS for Logic Level
- Logic Level Shift Transfer
- Small Package: TSSOP-20

Pin Assignments

(Top View)

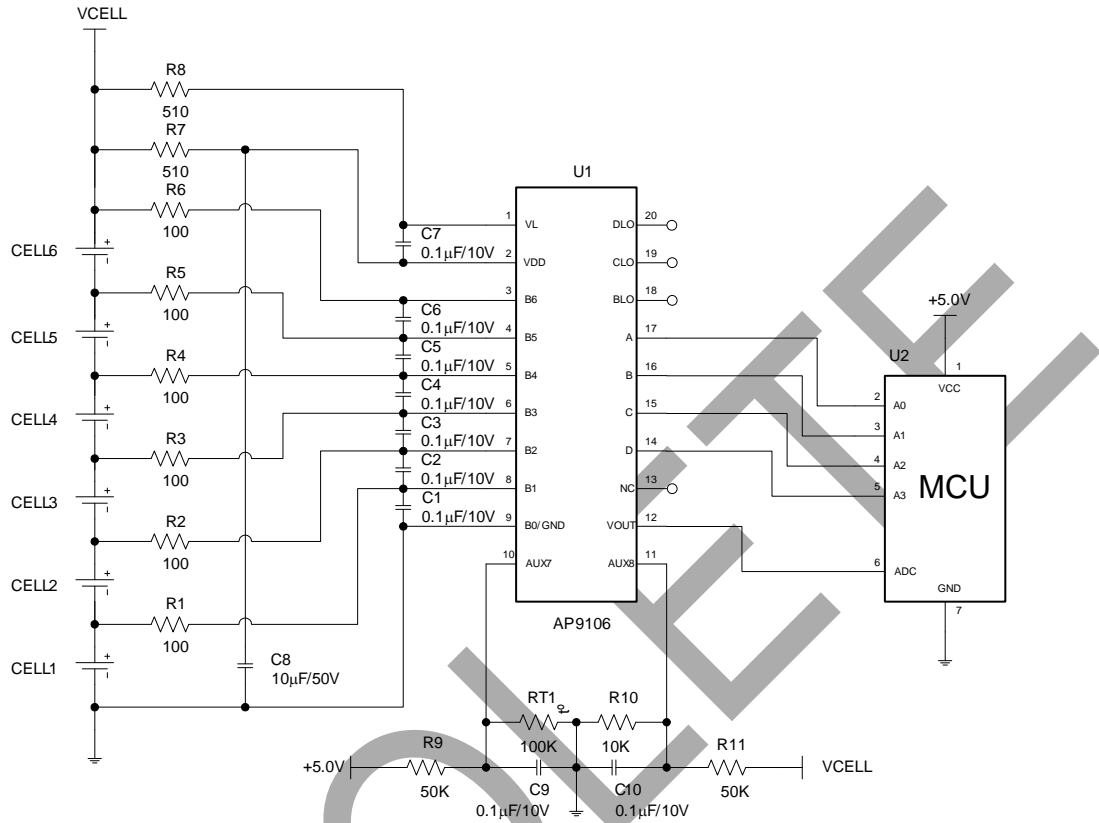


Applications

- E-Bike Li+ Battery Pack
- Electric Tool Battery Pack

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Typical Applications Circuit



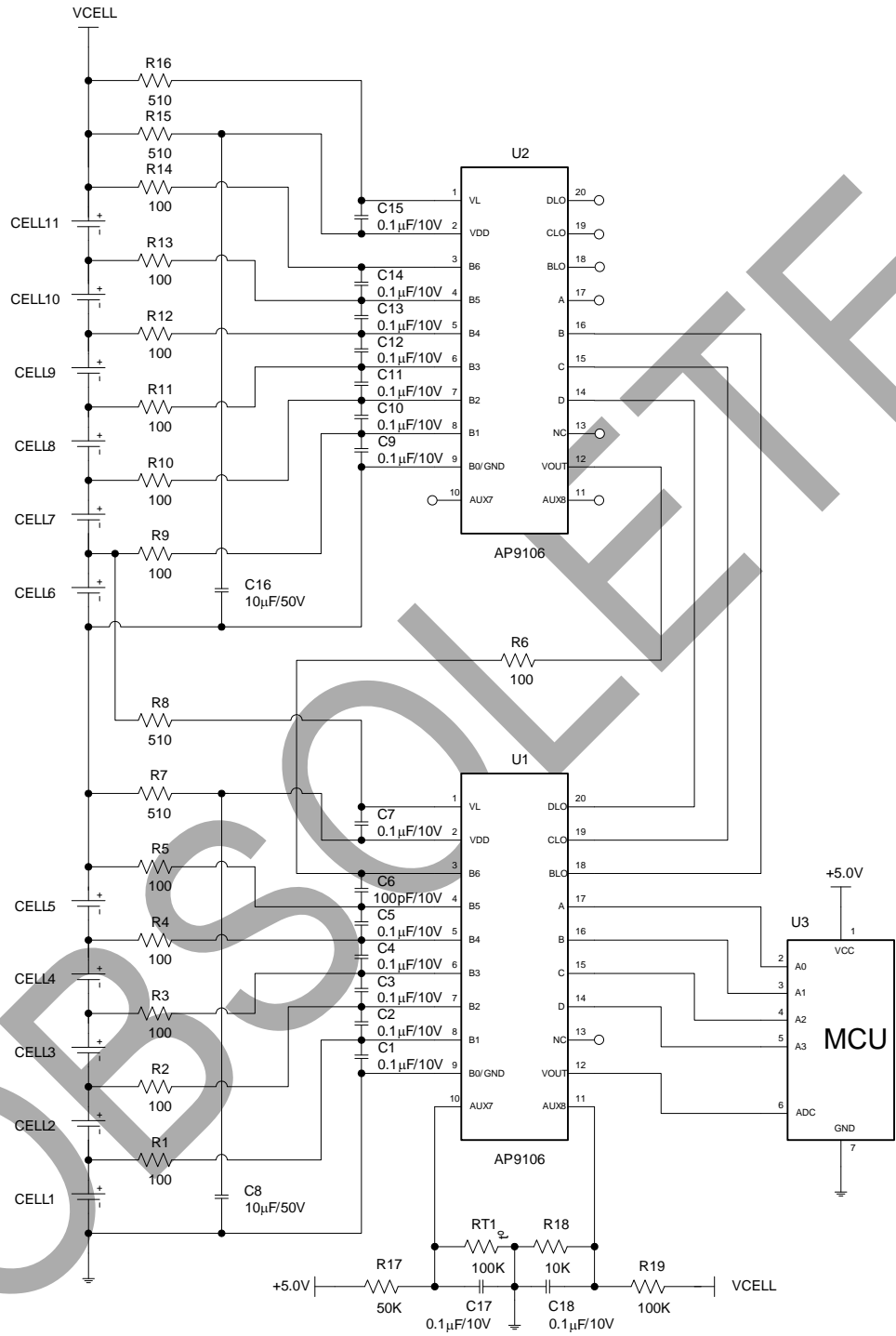
6-cell Battery (Single Chip) Application for AP9106

Truth Table for 6-cell (Single Chip) Battery Application

| Logic Input | | | | Active Channel | Output Voltage |
|-------------|---|---|---|--|----------------|
| A | B | C | D | | |
| 0 | 0 | 0 | 0 | All channels OFF, chip is in shutdown mode | 0V |
| 0 | 0 | 0 | 1 | QD1 | VCELL1 |
| 0 | 0 | 1 | 0 | QD2 | VCELL2 |
| 0 | 0 | 1 | 1 | QD3 | VCELL3 |
| 0 | 1 | 0 | 0 | QD4 | VCELL4 |
| 0 | 1 | 0 | 1 | QD5 | VCELL5 |
| 0 | 1 | 1 | 0 | QD6 | VCELL6 |
| 0 | 1 | 1 | 1 | QD7 | VTEMP |
| 1 | 0 | 0 | 0 | QD8 | VTCELL |

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Typical Applications Circuit (Cont.)



11-cell Battery (Dual Chips) Application for AP9106

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Truth Table for 11-cell (Dual Chips) Battery Application

| Logic Input | | | | Active Channel (Lower Chip) | Active Channel (Upper Chip) | Output Voltage |
|-------------|---|---|---|--|--|----------------|
| A | B | C | D | | | |
| 0 | 0 | 0 | 0 | All channels OFF, chip is in shutdown mode | All channels OFF, chip is in shutdown mode | 0V |
| 0 | 0 | 0 | 1 | QD1 | Shutdown mode | VCELL1 |
| 0 | 0 | 1 | 0 | QD2 | Shutdown mode | VCELL2 |
| 0 | 0 | 1 | 1 | QD3 | Shutdown mode | VCELL3 |
| 0 | 1 | 0 | 0 | QD4 | Shutdown mode | VCELL4 |
| 0 | 1 | 0 | 1 | QD5 | Shutdown mode | VCELL5 |
| 0 | 1 | 1 | 0 | QD6 | Shutdown mode | 0V |
| 0 | 1 | 1 | 1 | QD7 | Shutdown mode | VTEMP |
| 1 | 0 | 0 | 0 | QD8 | Shutdown mode | VTCELL |
| 1 | 0 | 0 | 1 | QD6 | QD1 | VCELL6 |
| 1 | 0 | 1 | 0 | QD6 | QD2 | VCELL7 |
| 1 | 0 | 1 | 1 | QD6 | QD3 | VCELL8 |
| 1 | 1 | 0 | 0 | QD6 | QD4 | VCELL9 |
| 1 | 1 | 0 | 1 | QD6 | QD5 | VCELL10 |
| 1 | 1 | 1 | 0 | QD6 | QD6 | VCELL11 |
| 1 | 1 | 1 | 1 | QD6 | QD7 | — |

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Pin Descriptions

| Pin Number | Pin Name | Function |
|------------|----------|--|
| 1 | VL | Level shift logic power supply |
| 2 | VDD | Power supply |
| 3 | B6 | Positive node of sixth battery cell |
| 4 | B5 | Positive node of fifth battery cell & negative node of sixth battery cell |
| 5 | B4 | Positive node of fourth battery cell & negative node of fifth battery cell |
| 6 | B3 | Positive node of third battery cell & negative node of fourth battery cell |
| 7 | B2 | Positive node of second battery cell & negative node of third battery cell |
| 8 | B1 | Positive node of first battery cell & negative node of second battery cell |
| 9 | B0(GND) | Ground and negative node of first battery cell |
| 10 | AUX7 | Auxiliary channel 7 |
| 11 | AUX8 | Auxiliary channel 8 |
| 12 | VOUT | Switch output pin |
| 13 | NC | No connected |
| 14 | D | Channel selection logic input D |
| 15 | C | Channel selection logic input C |
| 16 | B | Channel selection logic input B |
| 17 | A | Channel selection logic input A |
| 18 | BLO | Channel selection logic output B |
| 19 | CLO | Channel selection logic output C |
| 20 | DLO | Channel selection logic output D |

Notes:

1. VDD pin should always be connected to the positive node of top battery.
2. Voltage of VL pin should be equal to or larger than that of VDD pin.

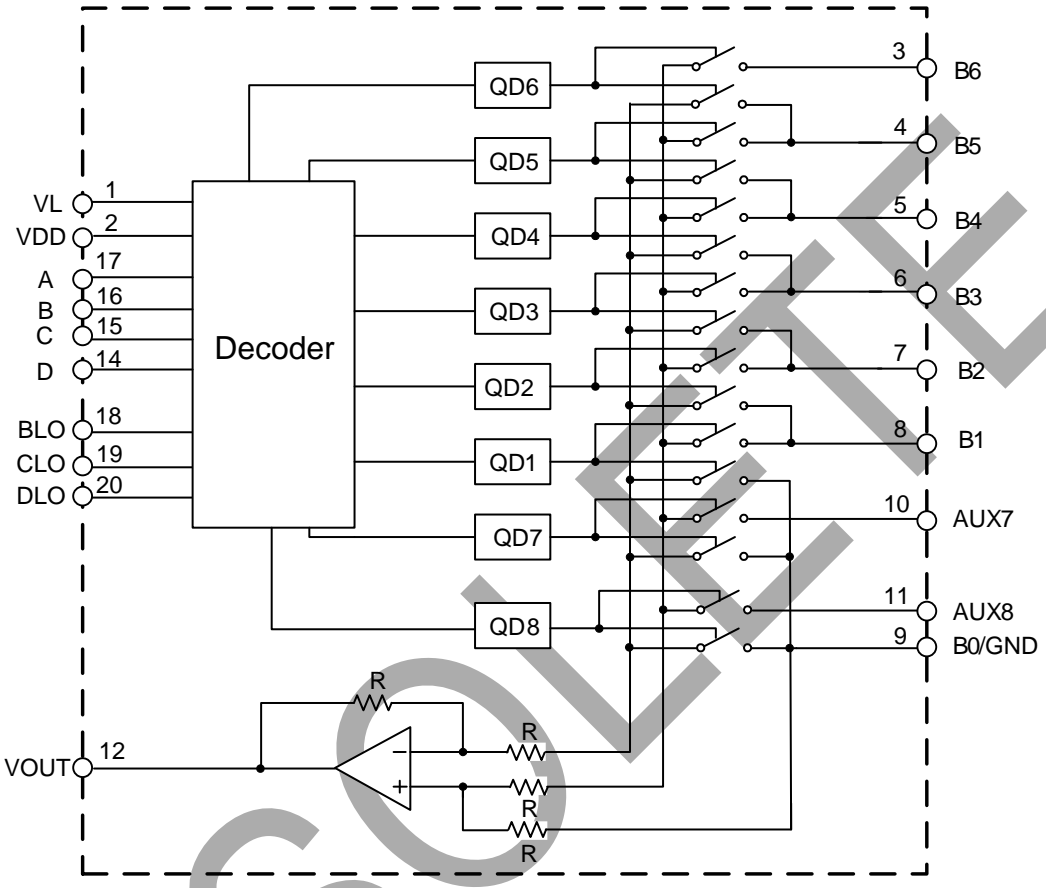
Truth Table and Relationship between Input Logic, Output Logic and Selected Channel

| Logic Input | | | | Logic Output | | | Active Channel | Output Voltage |
|-------------|---|---|---|--------------|-----|-----|--|----------------|
| A | B | C | D | BLO | CLO | DLO | | |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | All channels OFF, chip is in shutdown mode | 0V |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | QD1 | B1 vs. B0(GND) |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | QD2 | B2 vs. B1 |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | QD3 | B3 vs. B2 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | QD4 | B4 vs. B3 |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | QD5 | B5 vs. B4 |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | QD6 | B6 vs. B5 |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | QD7 | AUX7 vs. GND |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | QD8 | AUX8 vs. GND |
| 1 | 0 | 0 | 1 | 0 | 0 | 1 | QD6 | B6 vs. B5 |
| 1 | 0 | 1 | 0 | 0 | 1 | 0 | QD6 | B6 vs. B5 |
| 1 | 0 | 1 | 1 | 0 | 1 | 1 | QD6 | B6 vs. B5 |
| 1 | 1 | 0 | 0 | 1 | 0 | 0 | QD6 | B6 vs. B5 |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | QD6 | B6 vs. B5 |
| 1 | 1 | 1 | 0 | 1 | 1 | 0 | QD6 | B6 vs. B5 |
| 1 | 1 | 1 | 1 | 1 | 1 | 1 | QD6 | B6 vs. B5 |

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Functional Block Diagram



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Absolute Maximum Ratings (Note 3)

| Symbol | Parameter | Rating | Unit |
|-------------------|---|-------------|------|
| V _{DD} | Supply Voltage | -0.3 to 35 | V |
| V _{CELL} | Voltage between B _N and B _{N+1} , AUX7/AUX8 and GND | -0.3 to 5 | V |
| T _J | Operating Junction Temperature Range | +150 | °C |
| T _{STG} | Storage Temperature Range | -65 to +150 | °C |
| T _{LEAD} | Lead Temperature (Soldering, 10sec) | +260 | °C |
| θ _{JA} | Thermal Resistance | 80 | °C/W |
| — | ESD (Machine Model) | 200 | V |
| — | ESD (Human Body Model) | 2000 | V |

Note 3: Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “Recommended Operating Conditions” is not implied. Exposure to “Absolute Maximum Ratings” for extended periods may affect device reliability.

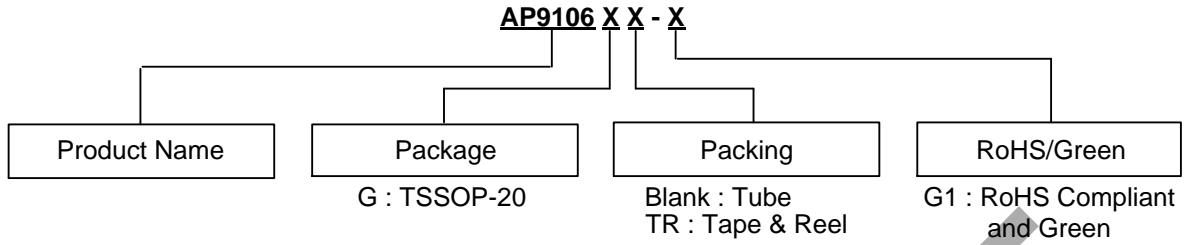
Recommended Operating Conditions

| Symbol | Parameter | Min | Max | Unit |
|----------------------------------|---|-----|-----|------|
| V _{DD} | Supply Voltage | 6.0 | 27 | V |
| V _{CELL} | Battery Cell Voltage | 2.0 | 4.5 | V |
| V _{IN} | Input Voltage (B6 vs. B5, B5 vs. B4, B4 vs. B3, B3 vs. B2, B2 vs. B1, B1 vs. GND, AUX7/8 vs. GND) | 2.0 | 4.5 | V |
| T _A | Operating Ambient Temperature | -40 | +85 | °C |
| V _{IL} /V _{IH} | Input Logic Level | 0 | 5.0 | V |

Electrical Characteristics ($V_{DD} = 21.6V$, $V_L = V_{DD} + 4.4V = 26V$, $T_A = +25^\circ C$, **Bold** typeface applies over full temperature $-40^\circ C \leq T_A \leq +85^\circ C$ ranges, unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|------------------------------------|---|--|------|----------|------|---------------|
| V_{DD} | Supply Voltage | — | 6.0 | — | 27 | V |
| I_Q | Quiescent Current | — | — | 0.2 | 0.5 | mA |
| I_{SHUT} | Shutdown Current | Set A, B, and C low | — | 1.0 | 2.0 | μA |
| OPAMP Output Voltage | | | | | | |
| V_{OS} | Offset Voltage | Input DC voltage: 2.9V to 4.2V | -100 | — | +100 | mV |
| V_{OL} | Output Voltage Switching | — | 2.0 | — | — | V |
| V_{OH} | | — | — | — | 4.5 | V |
| Switch | | | | | | |
| I_{BIAS} | Bias Current | For B2, B3, B4, B5 and B6 Pin | — | 10 | 15 | μA |
| | | For B1, AUX7, AUX8 Pin | — | — | 1 | |
| E_{MATCH} | Channel Matching Error between any 2 Channels | Set all channel DC: 2.9V to 4.2V, $T_A = -40$ to $+85^\circ C$, $(V_{MAX} - V_{MIN}) / \text{average}(\text{CH1 to CH7})$ | — | ± 1 | — | % |
| — | Channel Isolation | $f = 100\text{Hz}$ | — | -80 | — | dB |
| V_{NO} | Output Noise | $BW = 100\text{Hz}$, CH1 to CH7, DC input: 2.9V to 4.2V | — | 50 | — | μV_{RMS} |
| t_{SET} | Channel Switching & Set-up Time | — | — | 1.0 | — | ms |
| Logic Input (Voltage Mode) | | | | | | |
| V_{IH} | Logic Input High Level | A, B, C, D | 1.0 | — | 5.0 | V |
| V_{IL} | Logic Input Low Level | A, B, C, D | 0 | — | 0.6 | V |
| I_L | Input Leakage Current | Set A, B, C, D low | — | — | 1.0 | μA |
| $R_{PULL-DOWN}$ | Pull Down Resistor | A, B, C, D | — | 1.0 | — | M Ω |
| Logic Output (Voltage Mode) | | | | | | |
| V_{OL} | Logic Input Low Level | BLO, CLO, DLO | — | V_{DD} | — | V |
| V_{OH} | Logic Input High Level | BLO, CLO, DLO | — | V_L | — | V |

Ordering Information



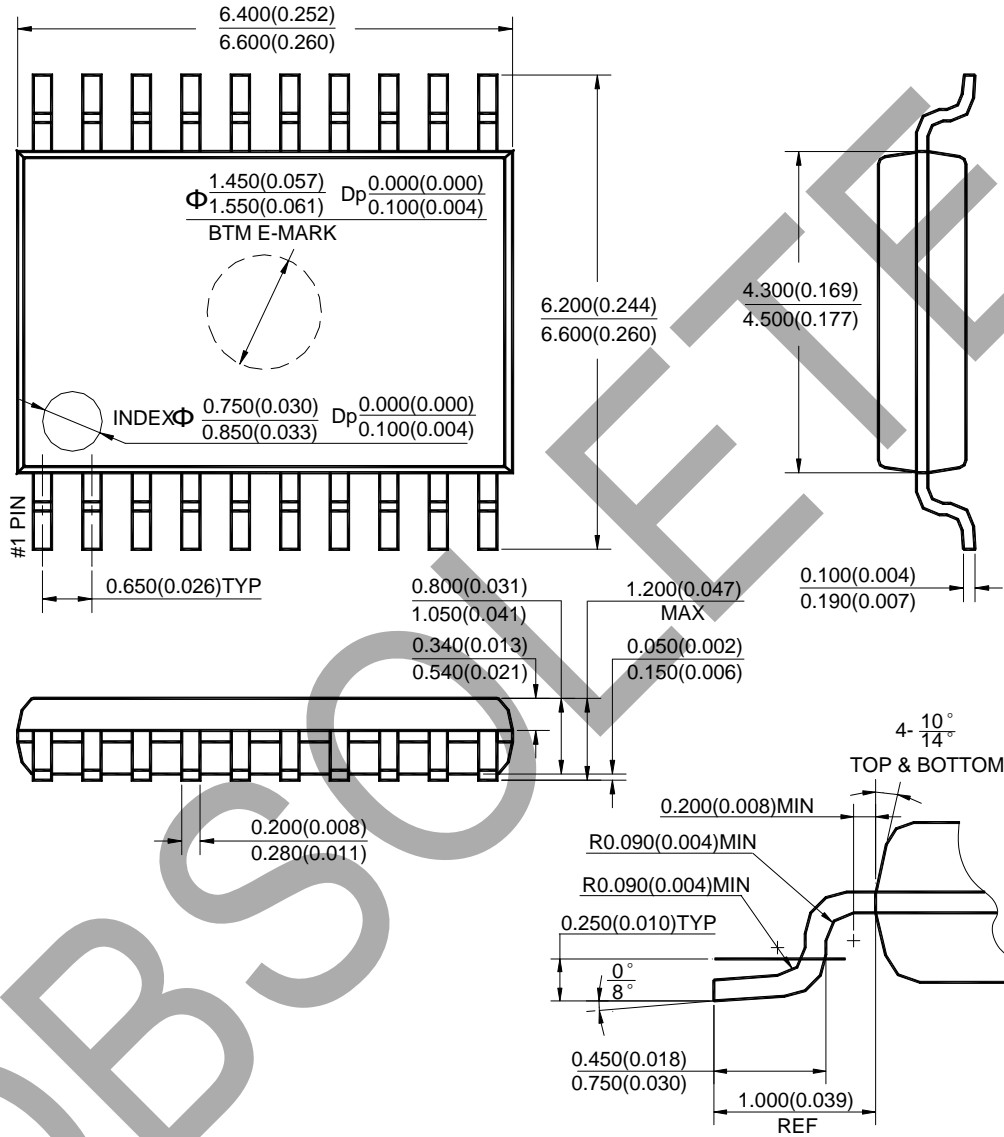
| Package | Temperature Range | Part Number | Marking ID | Packing |
|----------|-------------------|--------------|------------|-------------|
| TSSOP-20 | -40 to +85°C | AP9106G-G1 | AP9106GG | Tube |
| | | AP9106GTR-G1 | AP9106GG | Tape & Reel |

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Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: TSSOP-20



Note: Eject hole, oriented hole and mold mark is optional.

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